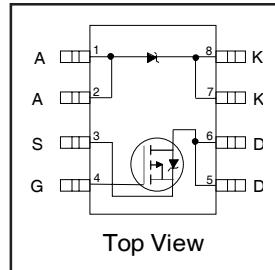


# International **IR** Rectifier

## IRF7322D1PbF

**FETKY™ MOSFET / Schottky Diode**

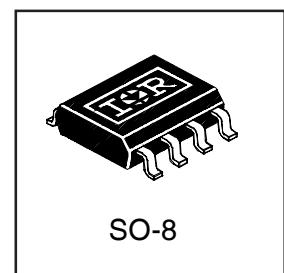
- Co-packaged HEXFET® Power MOSFET and Schottky Diode
- Ideal For Buck Regulator Applications
- P-Channel HEXFET
- Low  $V_F$  Schottky Rectifier
- Generation 5 Technology
- SO-8 Footprint
- Lead-Free



$V_{DSS} = -20V$
$R_{DS(on)} = 0.058\Omega$
Schottky $V_f = 0.39V$

### Description

The **FETKY** family of co-packaged MOSFETs and Schottky diodes offers the designer an innovative, board space saving solution for switching regulator and power management applications. Generation 5 HEXFET Power MOSFETs utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. Combining this technology with International Rectifier's low forward drop Schottky rectifiers results in an extremely efficient device suitable for use in a wide variety of portable electronics applications.



The SO-8 has been modified through a customized leadframe for enhanced thermal characteristics. The SO-8 package is designed for vapor phase, infrared or wave soldering techniques.

### Absolute Maximum Ratings ( $T_A = 25^\circ C$ unless otherwise noted)

Parameter	Maximum	Units
$I_D @ T_A = 25^\circ C$	Continuous Drain Current, $V_{GS} @ -4.5V$	A
$I_D @ T_A = 70^\circ C$		
$I_{DM}$	-43	
$P_D @ T_A = 25^\circ C$	Power Dissipation	W
$P_D @ T_A = 70^\circ C$		
$V_{GS}$	16	mW/°C
$V_{GS}$	± 12	V
$dv/dt$	Peak Diode Recovery $dv/dt$ ②	V/ns
$T_J, T_{STG}$	Junction and Storage Temperature Range	°C

### Thermal Resistance Ratings

Parameter	Maximum	Units
$R_{θJA}$	62.5	°C/W

#### Notes:

- ① Repetitive rating; pulse width limited by maximum junction temperature (see figure 9)
- ②  $I_{SD} \leq -2.9A$ ,  $di/dt \leq -77A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq 150^\circ C$
- ③ Pulse width  $\leq 300\mu s$ ; duty cycle  $\leq 2\%$
- ④ Surface mounted on FR-4 board,  $t \leq 10sec$ .

**MOSFET Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

Parameter		Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	-20	—	—	V	$V_{\text{GS}} = 0\text{V}$ , $I_D = -250\mu\text{A}$
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-Resistance	—	0.049	0.062	$\Omega$	$V_{\text{GS}} = -4.5\text{V}$ , $I_D = -2.9\text{A}$ ③
		—	0.082	0.098		$V_{\text{GS}} = -2.7\text{V}$ , $I_D = -1.5\text{A}$ ③
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	-0.70	—	—	V	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = -250\mu\text{A}$
$g_f$	Forward Transconductance	—	5.9	—	S	$V_{\text{DS}} = -10\text{V}$ , $I_D = -1.5\text{A}$
$I_{\text{DSS}}$	Drain-to-Source Leakage Current	—	—	-1.0	$\mu\text{A}$	$V_{\text{DS}} = -16\text{V}$ , $V_{\text{GS}} = 0\text{V}$
		—	—	-25		$V_{\text{DS}} = -16\text{V}$ , $V_{\text{GS}} = 0\text{V}$ , $T_J = 55^\circ\text{C}$
$I_{\text{GSS}}$	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{\text{GS}} = -12.0\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{\text{GS}} = 12.0\text{V}$
$Q_g$	Total Gate Charge	—	19	29	nC	$I_D = -2.9\text{A}$
$Q_{\text{gs}}$	Gate-to-Source Charge	—	4.0	6.1		$V_{\text{DS}} = -16\text{V}$
$Q_{\text{gd}}$	Gate-to-Drain ("Miller"') Charge	—	7.7	12		$V_{\text{GS}} = -4.5\text{V}$ (see figure 6) ③
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	15	22	ns	$V_{\text{DD}} = -10\text{V}$
$t_r$	Rise Time	—	40	60		$I_D = -2.9\text{A}$
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	42	63		$R_G = 6.0\Omega$
$t_f$	Fall Time	—	49	73		$R_D = 3.4\Omega$ ③
$C_{\text{iss}}$	Input Capacitance	—	780	—	pF	$V_{\text{GS}} = 0\text{V}$
$C_{\text{oss}}$	Output Capacitance	—	470	—		$V_{\text{DS}} = -15\text{V}$
$C_{\text{rss}}$	Reverse Transfer Capacitance	—	240	—		$f = 1.0\text{MHz}$ (see figure 5)

**MOSFET Source-Drain Ratings and Characteristics**

Parameter		Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	-2.5	A	
$I_{\text{SM}}$	Pulsed Source Current (Body Diode)	—	—	-21		
$V_{\text{SD}}$	Body Diode Forward Voltage	—	—	-1.2	V	$T_J = 25^\circ\text{C}$ , $I_S = -2.9\text{A}$ , $V_{\text{GS}} = 0\text{V}$
$t_{\text{rr}}$	Reverse Recovery Time (Body Diode)	—	47	71	ns	$T_J = 25^\circ\text{C}$ , $I_F = -2.9\text{A}$
$Q_{\text{rr}}$	Reverse Recovery Charge	—	49	73	nC	$dI/dt = 100\text{A}/\mu\text{s}$ ③

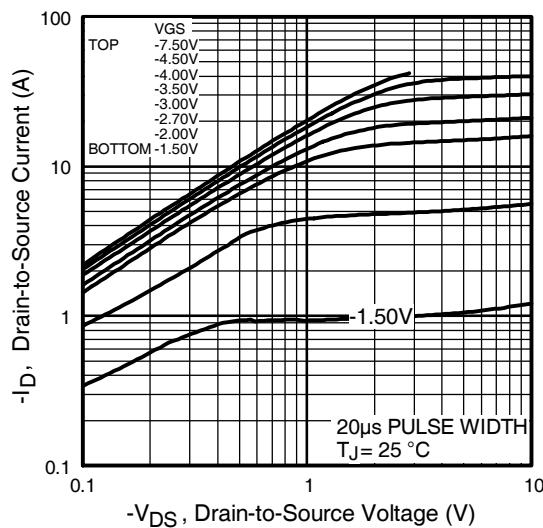
**Schottky Diode Maximum Ratings**

	Parameter	Max.	Units	Conditions	
$I_{\text{F(av)}}$	Max. Average Forward Current	2.7	A	50% Duty Cycle. Rectangular Wave, $T_A = 25^\circ\text{C}$	
		2		See Fig. 14 $T_A = 70^\circ\text{C}$	
$I_{\text{SM}}$	Max. peak one cycle Non-repetitive Surge current	120	A	5μs sine or 3μs Rect. pulse	Following any rated load condition & with $V_{\text{RRM}}$ applied
		11		10ms sine or 6ms Rect. pulse	

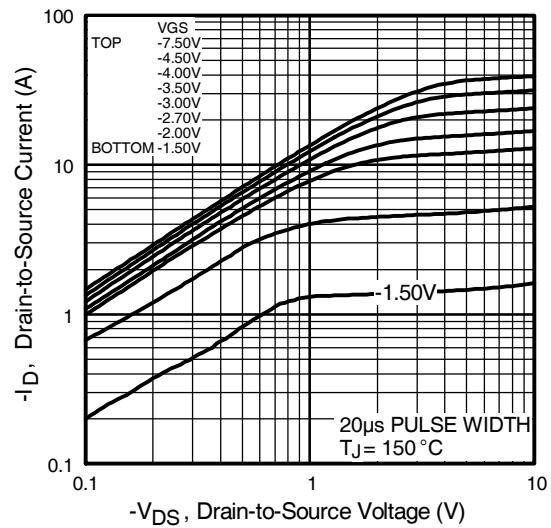
**Schottky Diode Electrical Specifications**

	Parameter	Max.	Units	Conditions	
$V_{\text{FM}}$	Max. Forward voltage drop	0.50	V	$I_F = 1.0\text{A}$ , $T_J = 25^\circ\text{C}$	
		0.62		$I_F = 2.0\text{A}$ , $T_J = 25^\circ\text{C}$	
		0.39		$I_F = 1.0\text{A}$ , $T_J = 125^\circ\text{C}$	
		0.57		$I_F = 2.0\text{A}$ , $T_J = 125^\circ\text{C}$ .	
$I_{\text{RM}}$	Max. Reverse Leakage current	0.02	mA	$V_R = 20\text{V}$	$T_J = 25^\circ\text{C}$
		8			$T_J = 125^\circ\text{C}$
$C_t$	Max. Junction Capacitance	92	pF	$V_R = 5\text{Vdc}$ ( 100kHz to 1 MHz) $25^\circ\text{C}$	
$dv/dt$	Max. Voltage Rate of Change	3600	V/μs	Rated $V_R$	

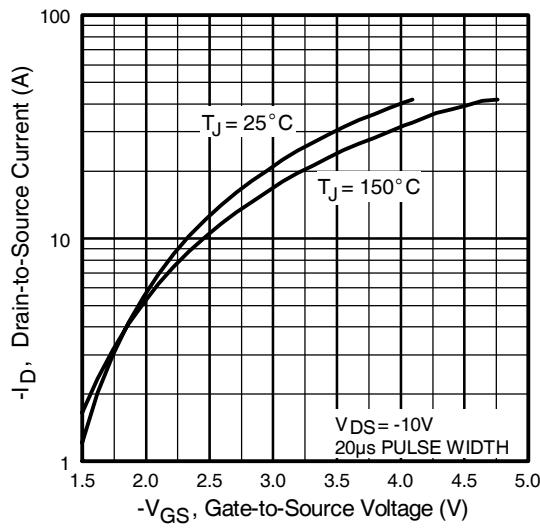
## Power Mosfet Characteristics



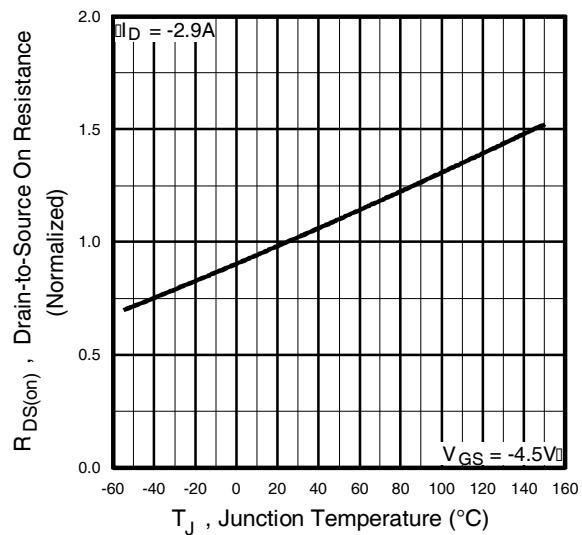
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics



**Fig 3.** Typical Transfer Characteristics

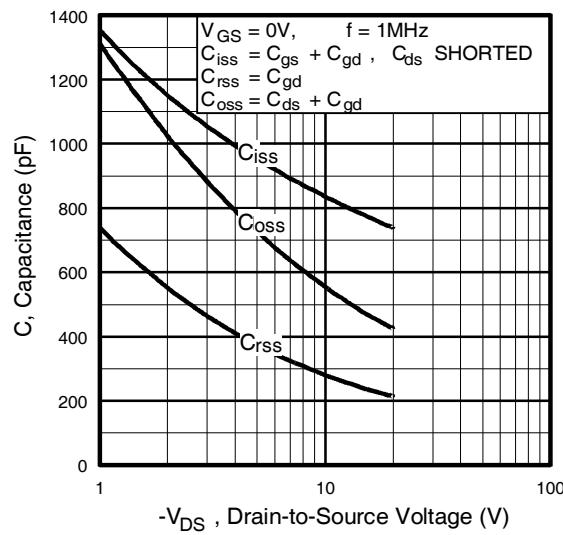


**Fig 4.** Normalized On-Resistance Vs. Temperature

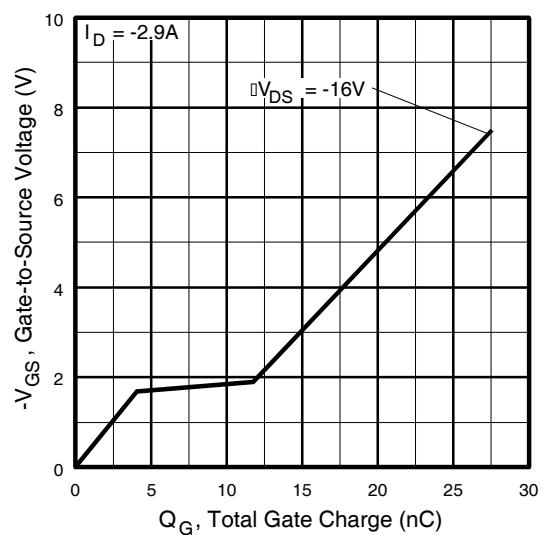
# IRF7322D1PbF

## Power Mosfet Characteristics

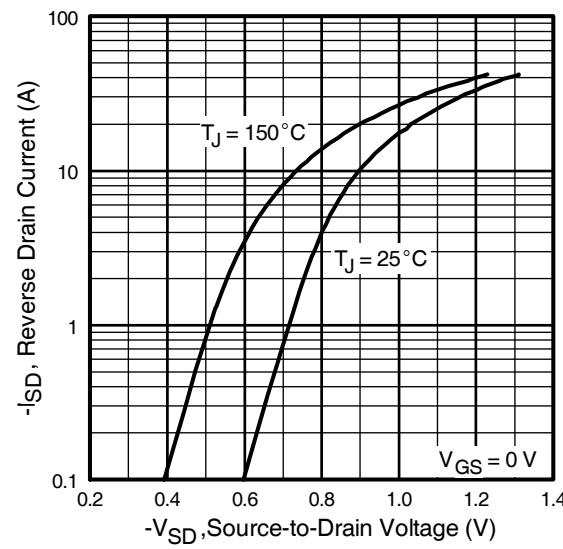
International  
**IR** Rectifier



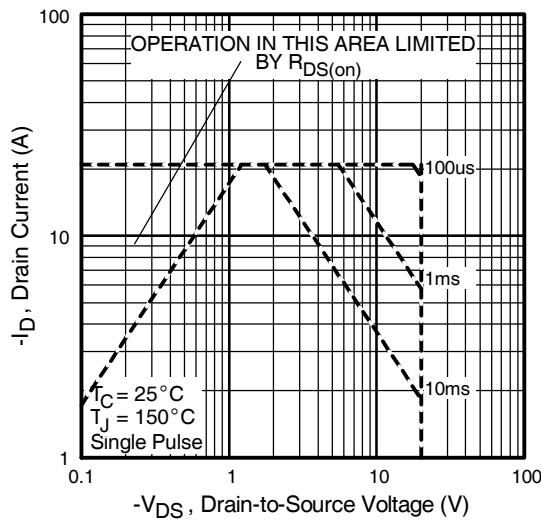
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage

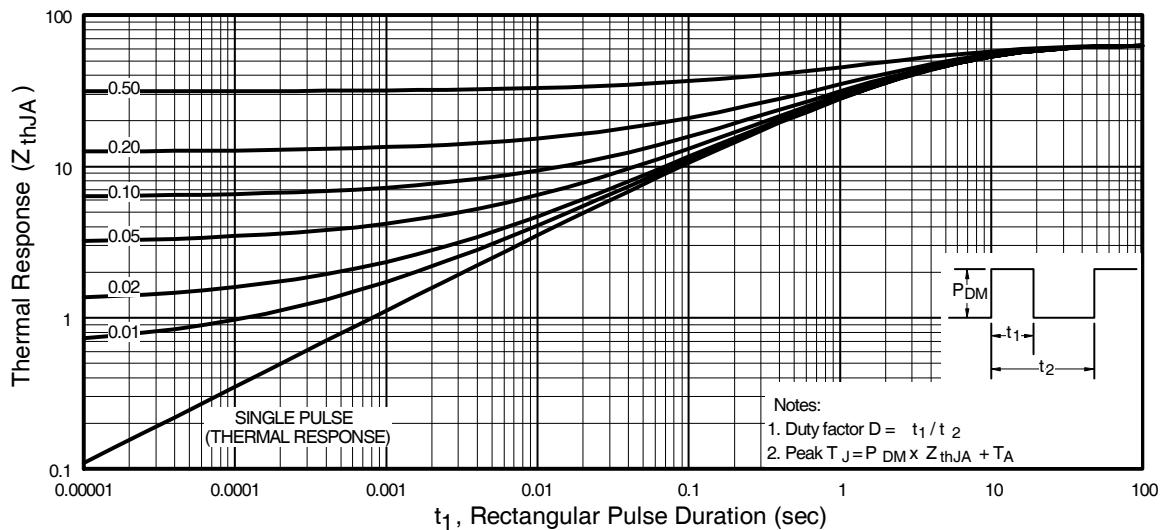


**Fig 7.** Typical Source-Drain Diode  
Forward Voltage

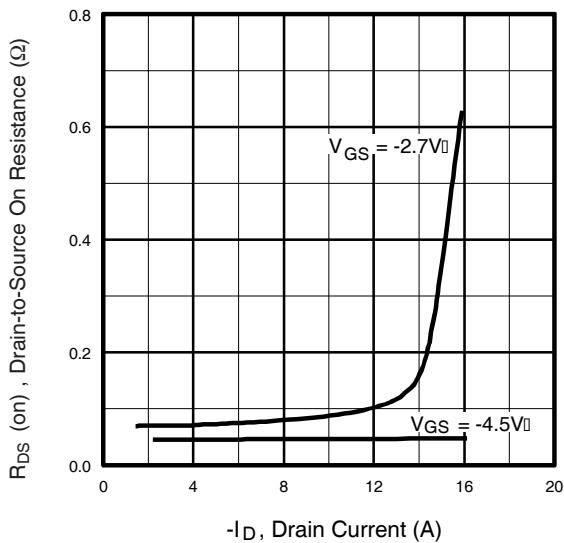


**Fig 8.** Maximum Safe Operating Area

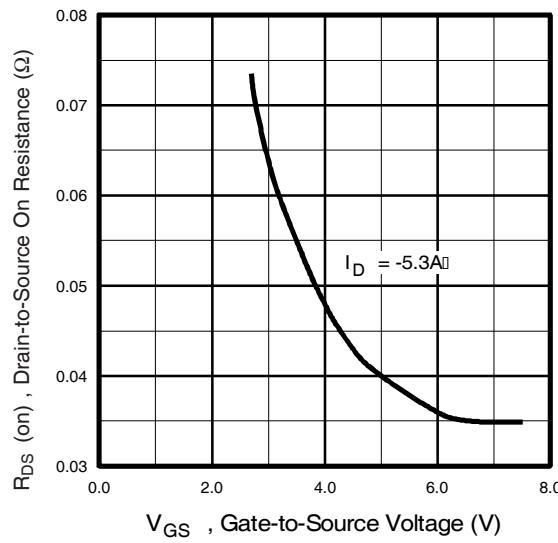
**Power Mosfet Characteristics**



**Fig 9.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



**Fig 10.** Typical On-Resistance Vs. Drain Current



**Fig 11.** Typical On-Resistance Vs. Gate Voltage

# IRF7322D1PbF

International  
**IR** Rectifier

## Schottky Diode Characteristics

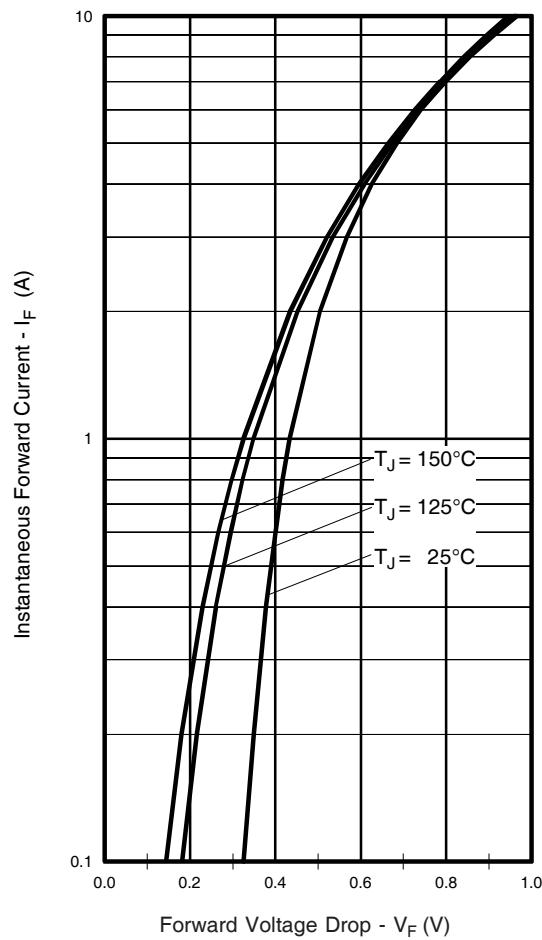


Fig. 12 - Typical Forward Voltage Drop Characteristics

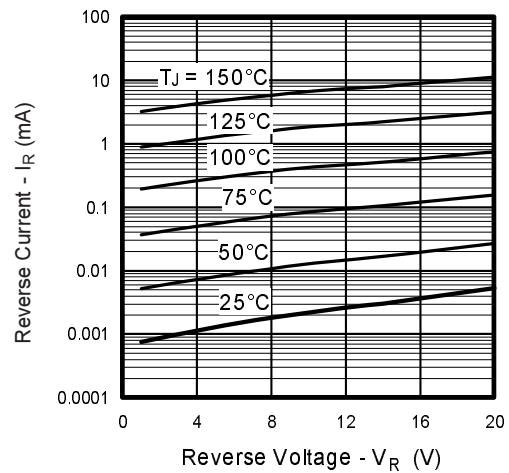


Fig. 13 - Typical Values of Reverse Current Vs. Reverse Voltage

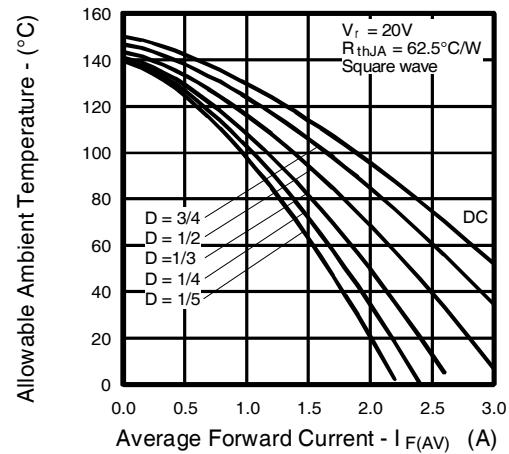
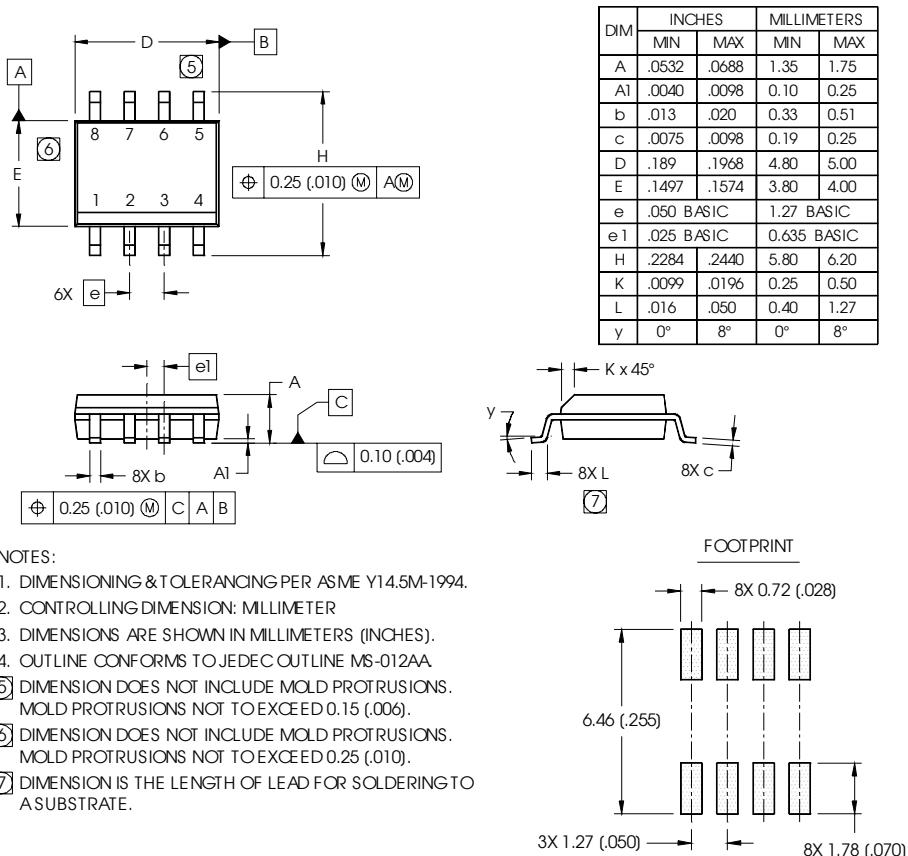


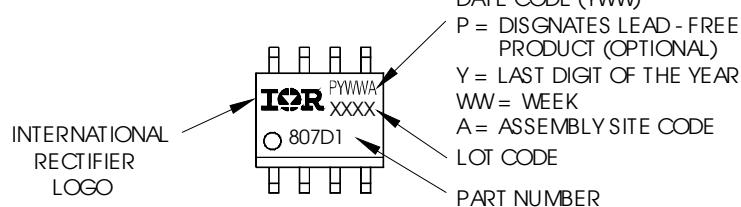
Fig.14 - Maximum Allowable Ambient Temp. Vs. Forward Current

### SO-8 (Fetky) Package Outline



### SO-8 (Fetky) Part Marking Information

EXAMPLE: THIS IS AN IRF7807D1 (FETKY)

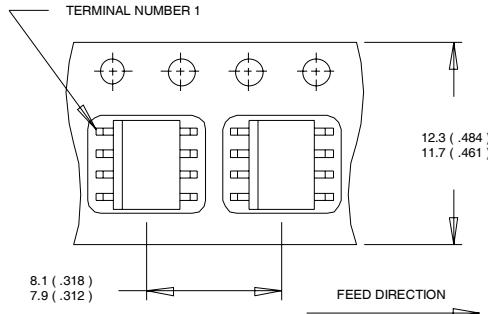


# IRF7322D1PbF

International  
**IR** Rectifier

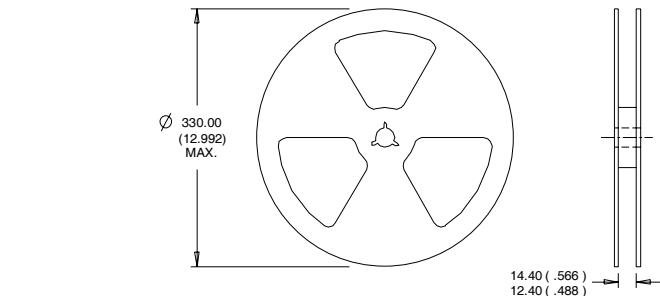
## SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice.  
This product has been designed and qualified for the Consumer market.  
Qualifications Standards can be found on IR's Web site.

International  
**IR** Rectifier

**IR WORLD HEADQUARTERS:** 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105  
TAC Fax: (310) 252-7903  
Visit us at [www.irf.com](http://www.irf.com) for sales contact information. 10/04  
[www.irf.com](http://www.irf.com)

# X-ON Electronics

Largest Supplier of Electrical and Electronic Components

***Click to view similar products for MOSFET category:***

***Click to view products by Infineon manufacturer:***

Other Similar products are found below :

[614233C](#) [648584F](#) [IRFD120](#) [JANTX2N5237](#) [FCA20N60\\_F109](#) [FDZ595PZ](#) [2SK2545\(Q,T\)](#) [405094E](#) [423220D](#) [TPCC8103,L1Q\(CM](#)  
[MIC4420CM-TR](#) [VN1206L](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [SSM6J414TU,LF\(T](#) [751625C](#) [BUK954R8-60E](#) [GROUP A 5962-](#)  
[8877003PA](#) [NTE6400](#) [SQJ402EP-T1-GE3](#) [2SK2614\(TE16L1,Q\)](#) [2N7002KW-FAI](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [ECH8691-TL-W](#)  
[FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#) [NTE221](#) [NTE222](#) [NTE2384](#) [NTE2903](#) [NTE2941](#) [NTE2945](#) [NTE2946](#) [NTE2960](#)  
[NTE2967](#) [NTE2969](#) [NTE2976](#) [NTE6400A](#) [NTE2910](#) [NTE2916](#) [NTE2956](#) [NTE2911](#) [DMN2080UCB4-7](#) [TK10A80W,S4X\(S](#)  
[SSM6P69NU,LF](#) [DMP22D4UFO-7B](#) [DMN1006UCA6-7](#)